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NPN Built-in Resistor Transistor CMPAK Series Inverter, Driver, Switching



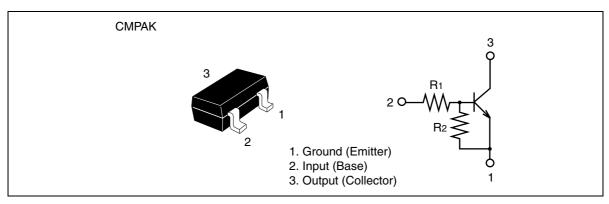
ADE-208-1445B (Z)

Rev.2 Sep. 2001

Features

- Built-in Resistor Type
- Simplifies Circuit Design
- Reduces Board Space
- Complementary pair with BRA144ECM series

Outline



Note: Marking is shown in below.

Device	Marking	R1 (kΩ)	R2 (kΩ)
BRC144ECM	BG	47	47
BRC124ECM	DG	22	22
BRC114ECM	FG	10	10
BRC143ECM	HG	4.7	4.7
BRC123ECM	KG	2.2	2.2

Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

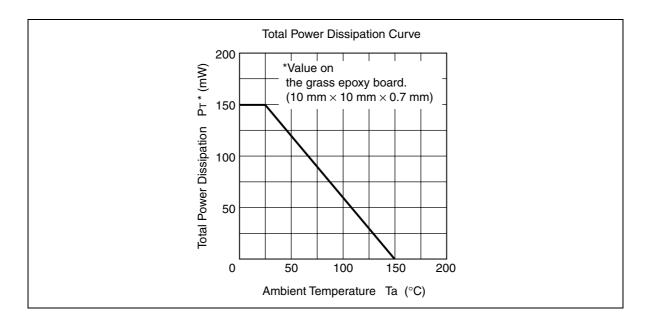
Item		Symbol	Ratings	Unit
Supply voltage		V _{cc}	50	V
Input voltage	BRC144ECM	V,	-10 to +40	V
	BRC124ECM		-10 to +30	
	BRC114ECM		-10 to +20	
	BRC143ECM		-10 to +15	
	BRC123ECM		-10 to +12	
Output current		I _o	100	mA
Total power dissipation		P,*	150	mW
Junction temperatu	lunction temperature		150	°C
Storage temperature		Tstg	−55 to +150	°C

^{*}Value on the glass epoxy board. (10 mm \times 10 mm \times 0.7 mm)

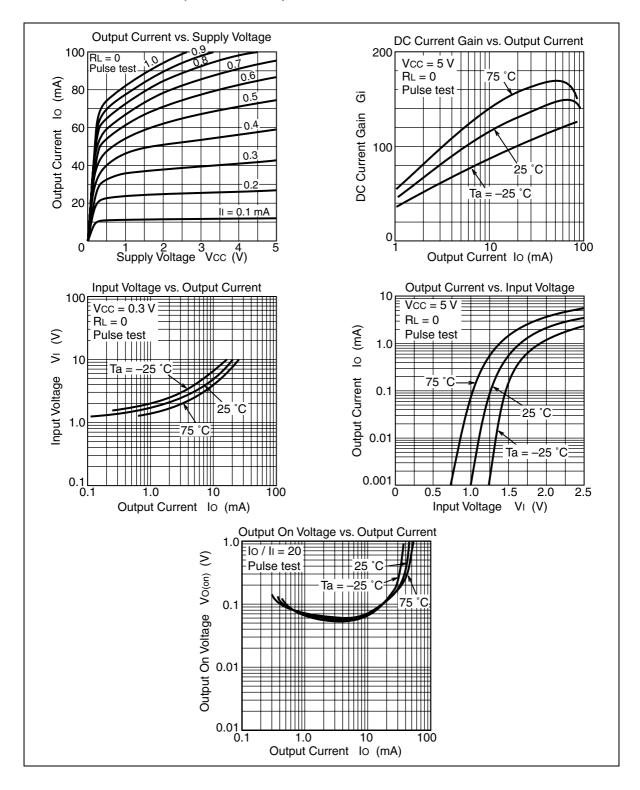
Electrical Characteristics

 $(Ta = 25^{\circ}C)$

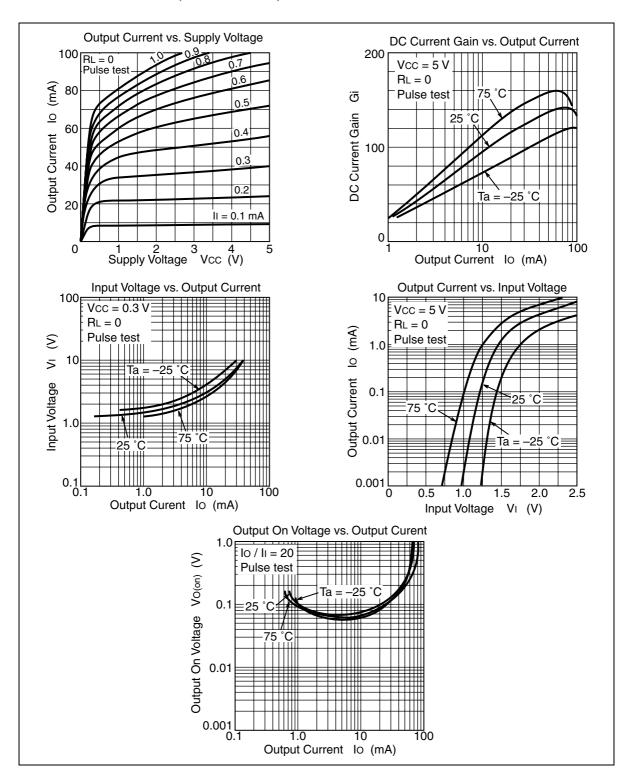
Item		Symbol	Min	Тур	Max	Unit	Test conditions
Input on voltage	BRC144ECM	V _{I(on)}	1.5	_	4.5	V	$V_{cc} = 0.3 \text{ V}, I_{o} = 5 \text{ mA}$
	BRC124ECM	_	1.3	_	3.0		
	BRC114ECM	_	1.2	_	2.4		
	BRC143ECM	_	1.1	_	2.0		
	BRC123ECM	_	1.1	_	1.8		
Input off voltage	BRC144ECM	V _{I(off)}	1.0	_	1.5	V	$V_{cc} = 5 \text{ V}, I_{o} = 100 \mu\text{A}$
	BRC124ECM	- '''	1.0	_	1.5	_	
	BRC114ECM		1.0	_	1.5		
	BRC143ECM	_	1.0	_	1.5		
	BRC123ECM	_	1.0	_	1.5		
Output saturation voltage		$V_{_{O(on)}}$	_	_	0.3	V	$I_0 = 10 \text{ mA}, I_1 = 0.5 \text{ mA}$
Output cutoff current		I _{O(off)}	_	_	0.5	μΑ	$V_{cc} = 50 \text{ V}, I_{i} = 0$
DC current transfer ratio	BRC144ECM	Gi	70	_	_		$V_{cc} = 5 \text{ V}, I_o = 5 \text{ mA}$
	BRC124ECM	- -	56	_	_	<u>_</u> _	
	BRC114ECM		30	_	_		
	BRC143ECM		20	_	_		$V_{cc} = 5 \text{ V}, I_{o} = 10 \text{ mA}$
	BRC123ECM	_	20	_	_		$V_{cc} = 5 \text{ V}, I_{o} = 20 \text{ mA}$
Input resistance	BRC144ECM	R ₁	33	47	61	kΩ	
	BRC124ECM	_	15	22	28		
	BRC114ECM	_	7	10	13		
	BRC143ECM	_	3.3	4.7	6.1		
	BRC123ECM	_	1.5	2.2	2.8		
Resistance ratio		R ₁ /R ₂	8.0	1.0	1.2		



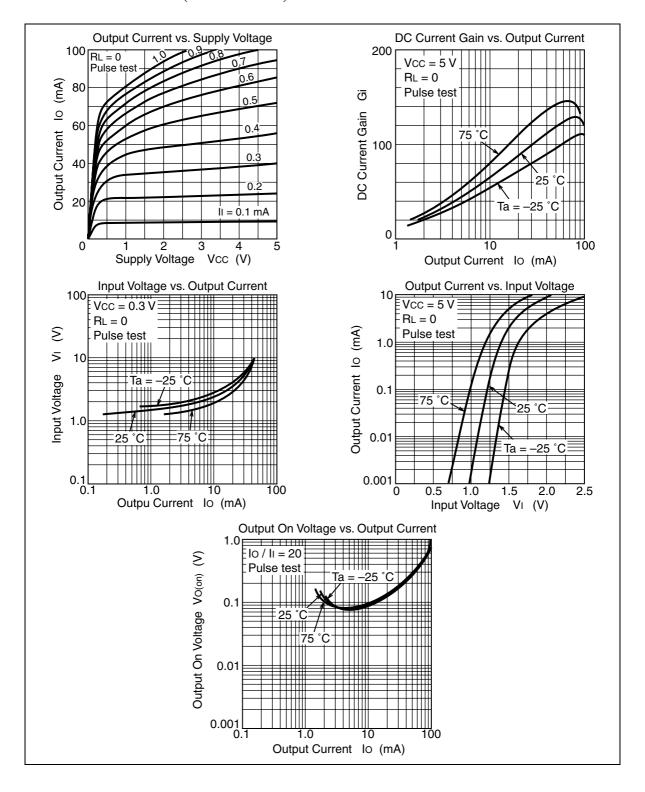
Main Characteristics (BRC144ECM)



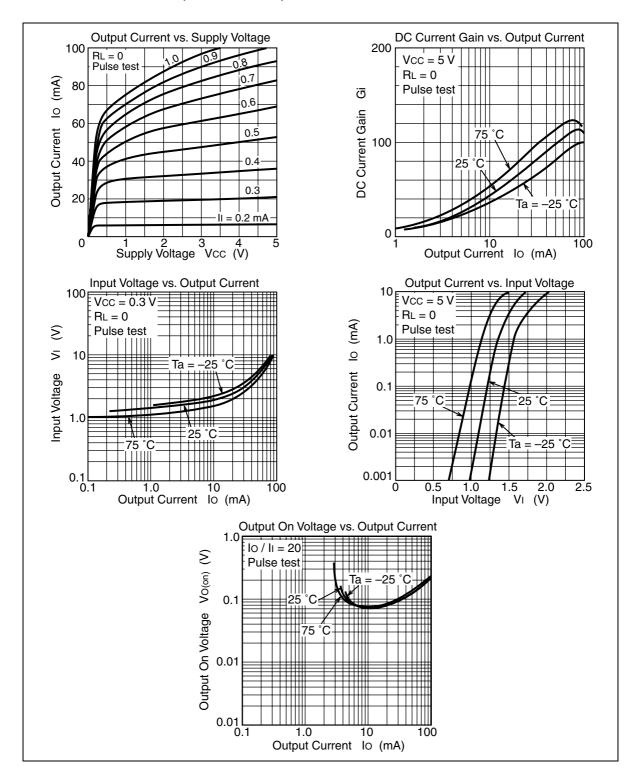
Main Characteristics (BRC124ECM)



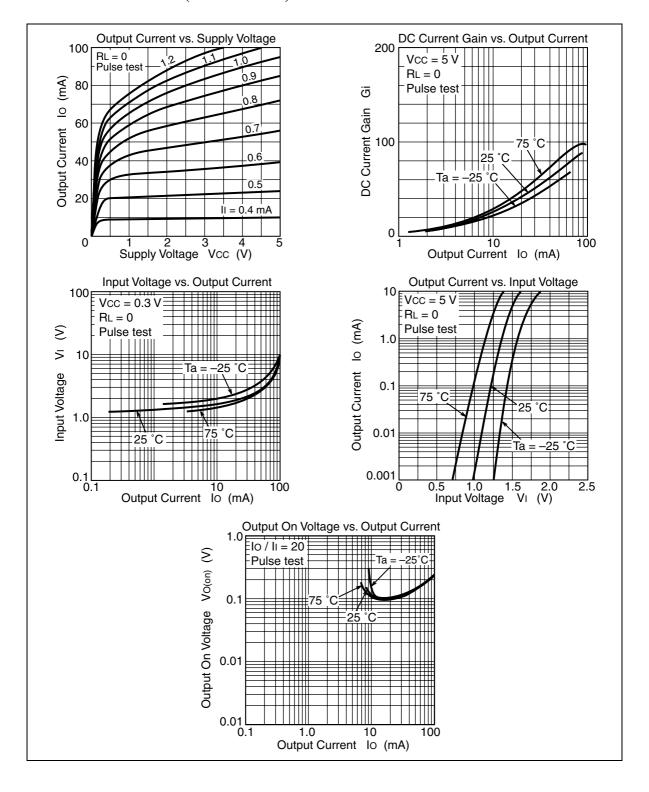
Main Characteristics (BRC114ECM)



Main Characteristics (BRC143ECM)



Main Characteristics (BRC123ECM)



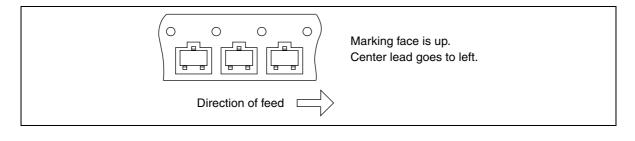
Taping Specification

There are two different size reels in CMPAK packaging.

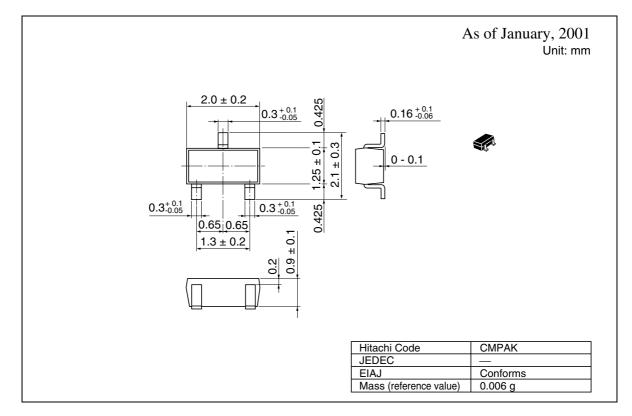
Packing to "Left" direction

Purchasing Identification Code

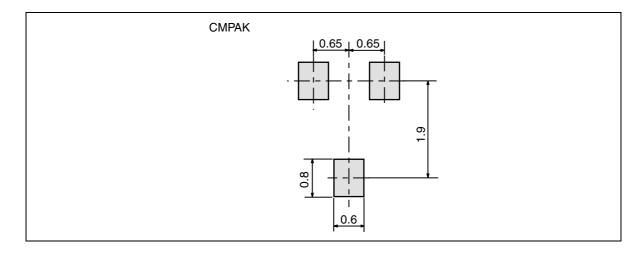
Standard Reel 3000 pcs/reel: Type No. + Mark TL Large Reel 12000 pcs/reel: Type No. + Mark UL



Package Dimensions



Footprint



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